



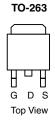
# N-Channel 40-V (D-S) 175 °C MOSFET

PRODUCT SUMMARY			
V <sub>(BR)DSS</sub> (V)	$r_{DS(on)}(\Omega)$	I <sub>D</sub> (A)	
40	0.0035 at V <sub>GS</sub> = 10 V	110 <sup>a</sup>	

#### **FEATURES**

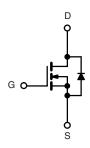
- TrenchFET® Power MOSFET
- 175 °C Junction Temperature





Ordering Information: SUM110N04-04

SUM110N04-04-E3 (Lead (Pb)-free)



N-Channel MOSFET

ABSOLUTE MAXIMUM RATING	<b>3S</b> $T_C = 25  ^{\circ}C$ , unless of	herwise noted			
Parameter		Symbol	Limit	Unit	
Drain-Source Voltage		V <sub>DS</sub>	40	V	
Gate-Source Voltage		V <sub>GS</sub>	20	<b> </b>	
Continuous Drain Current (T, = 175 °C)	T <sub>C</sub> = 25 °C	I-	110 <sup>a</sup>		
Continuous Diam Current (1) = 173 O)	T <sub>C</sub> = 125 °C	I <sub>D</sub>	107 <sup>a</sup>	A	
Pulsed Drain Current		I <sub>DM</sub>	350		
Avalanche Current		I <sub>AR</sub>	60		
Repetitive Avalanche Energy <sup>b</sup>	L = 0.1 mH	E <sub>AR</sub>	180	mJ	
	T <sub>C</sub> = 25 °C	P <sub>D</sub>	250 <sup>c</sup>	W	
Maximum Power Dissipation <sup>b</sup>	T <sub>A</sub> = 25 °C <sup>d</sup>	- FD	3.75	VV	
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	- 55 to 175	°C	

THERMAL RESISTANCE RATINGS				
Parameter		Symbol	Limit	Unit
Junction-to-Ambient	(PCB Mount) <sup>d</sup>	R <sub>thJA</sub>	40	°C/W
Junction-to-Case		R <sub>thJC</sub>	0.6	C/VV

#### Notes:

- a. Package limited.
- b. Duty cycle ≤ 1 %.
- c. See SOA curve for voltage derating.
- d. When mounted on 1" square PCB (FR-4 material).

<sup>\*</sup> Pb containing terminations are not RoHS compliant, exemptions may apply.

# SUM110N04-04

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<b>SPECIFICATIONS</b> $T_J = 25$ °C, unless otherwise noted						
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Static						
Drain-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	$V_{DS} = 0 \text{ V}, I_{D} = 250 \mu\text{A}$	40			V
Gate Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_D = 250 \mu A$	2		4	v
Gate-Body Leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = 20 \text{ V}$			100	nA
Zero Gate Voltage Drain Current		$V_{DS} = 40 \text{ V}, V_{GS} = 0 \text{ V}$			1	μΑ
	I <sub>DSS</sub>	$V_{DS} = 40 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 125 ^{\circ}\text{C}$			50	
		V <sub>DS</sub> = 40 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 175 °C			250	
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	120			Α
Drain-Source On-State Resistance <sup>a</sup>		V <sub>GS</sub> = 10 V, I <sub>D</sub> = 30 A		0.0028	0.0035	
	r <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 30 A, T <sub>J</sub> = 125 °C			0.0055	Ω
		V <sub>GS</sub> = 10 V, I <sub>D</sub> = 30 A, T <sub>J</sub> = 175 °C			0.006	
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = 15 V, I <sub>D</sub> = 30 A	30			S
Dynamic <sup>b</sup>						
Input Capacitance	C <sub>iss</sub>			6800		pF
Output Capacitance	C <sub>oss</sub>	$V_{GS} = 0 \text{ V}, V_{DS} = 25 \text{ V}, f = 1 \text{ MHz}$		1110		
Reverse Transfer Capacitance	C <sub>rss</sub>			690		
Total Gate Charge <sup>c</sup>	Qg			140	200	nC
Gate-Source Charge <sup>c</sup>	Q <sub>gs</sub>	$V_{DS} = 30 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 110 \text{ A}$		35		
Gate-Drain Charge <sup>c</sup>	$Q_{gd}$			55		
Turn-On Delay Time <sup>c</sup>	t <sub>d(on)</sub>			20	35	ns
Rise Time <sup>c</sup>	t <sub>r</sub>	$V_{DD} = 30 \text{ V}, R_{L} = 0.47 \Omega$		115	175	
Turn-Off Delay Time <sup>c</sup>	t <sub>d(off)</sub>	$I_D \cong 110 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 2.5 \Omega$		75	115	
Fall Time <sup>c</sup>	t <sub>f</sub>			85	130	
Source-Drain Diode Ratings and Ch	aracteristics 7	r <sub>C</sub> = 25 °C <sup>b</sup>			<u> </u>	
Continuous Current	Is				110	А
Pulsed Current	I <sub>SM</sub>				350	
Forward Voltage <sup>a</sup>	V <sub>SD</sub>	I <sub>F</sub> = 110 A, V <sub>GS</sub> = 0 V		1.1	1.4	V
Reverse Recovery Time	t <sub>rr</sub>			50	80	ns
Peak Reverse Recovery Current	I <sub>RM(REC)</sub>	I <sub>F</sub> = 110 A, di/dt = 100 A/μs		2	3	Α
Reverse Recovery Charge	Q <sub>rr</sub>			0.05	0.12	μС

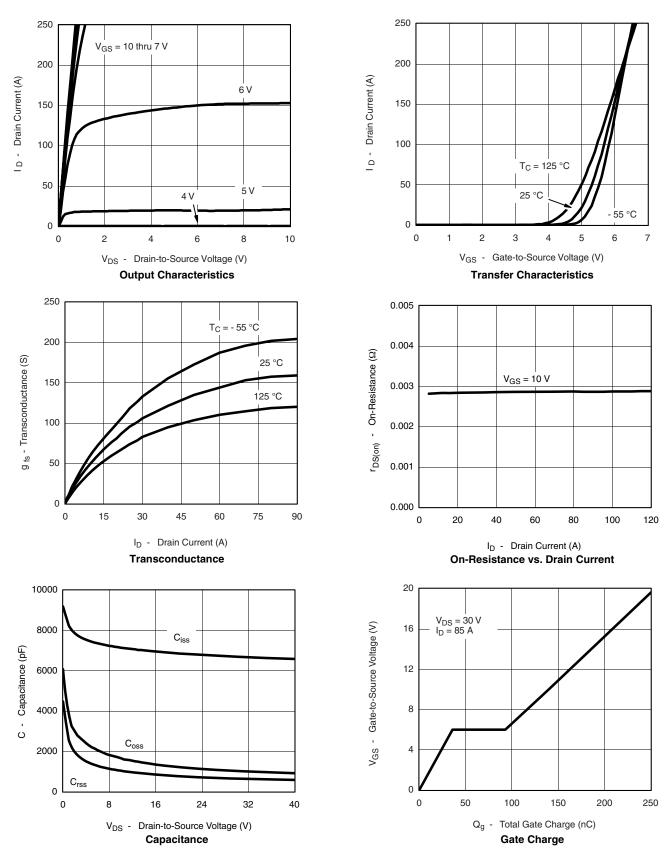
#### Notes:

- a. Pulse test; pulse width  $\leq 300~\mu s,$  duty cycle  $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.
- c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



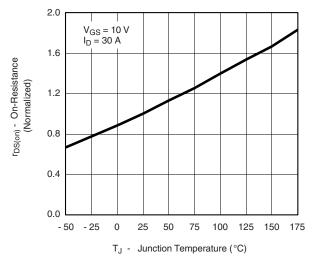
### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



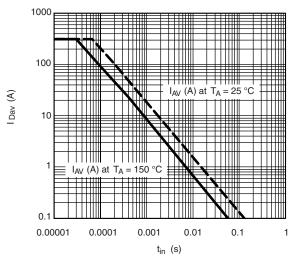
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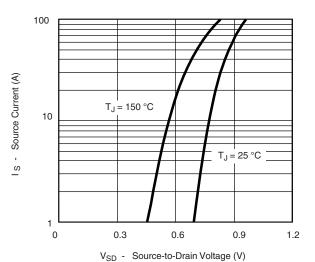
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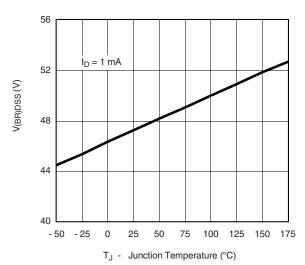
On-Resistance vs. Junction Temperature



**Avalanche Current vs. Time** 



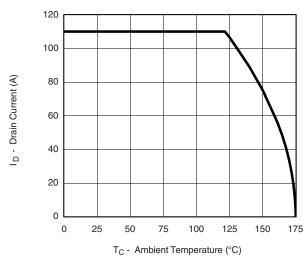
Source-Drain Diode Forward Voltage



Drain Source Breakdown vs. Junction Temperature



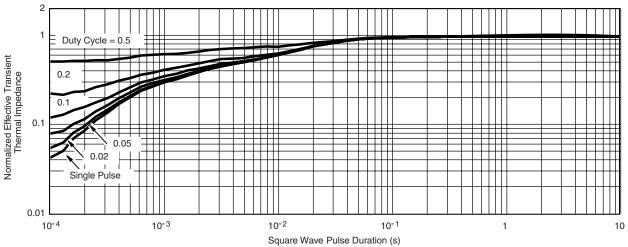
#### THERMAL RATINGS



1000 100 I<sub>D</sub> - Drain Current (A) ms 10 ms 10 100 ms DC T<sub>C</sub> = 25 °C Single Pulse 0.1 0.1 10 100 V<sub>DS</sub> - Drain-to-Source Voltage (V) \*  $V_{GS}$  > minimum  $V_{GS}$  at which  $r_{DS(on)}$  is specified

Maximum Avalanche and Drain Current vs. Case Temperature





Normalized Thermal Transient Impedance, Junction-to-Case

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